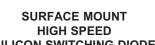
### **CMOD4448**

# **HIGH SPEED** SILICON SWITCHING DIODE





www.centralsemi.com

### **DESCRIPTION:**

The CENTRAL SEMICONDUCTOR CMOD4448 type is a ultra-high speed silicon switching diode manufactured by the epitaxial planar process, epoxy molded in an ULTRAmini™ surface mount package, designed for high speed switching applications.

**MARKING CODE: 48** 



MAXIMUM RATINGS: (T <sub>A</sub> =25°C)	SYMBOL		UNITS
Continuous Reverse Voltage	$V_{R}$	75	V
Peak Repetitive Reverse Voltage	$V_{RRM}$	100	V
Continuous Forward Current	l <sub>F</sub>	250	mA
Peak Repetitive Forward Current	I <sub>FRM</sub>	500	mA
Peak Forward Surge Current, tp=1.0µs	I <sub>FSM</sub>	4.0	Α
Peak Forward Surge Current, tp=1.0s	I <sub>FSM</sub>	1.0	Α
Power Dissipation	$P_{D}$	250	mW
Operating and Storage Junction Temperature	T <sub>J</sub> , T <sub>stg</sub>	-65 to +150	°C
Thermal Resistance	$\Theta_{\sf JA}$	500	°C/W

# $\textbf{ELECTRICAL CHARACTERISTICS:} \ (T_{\mbox{\scriptsize A}} = 25^{\circ}\mbox{C unless otherwise noted})$

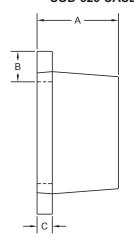
SYMBOL	TEST CONDITIONS	MIN	MAX	UNITS
$I_{R}$	V <sub>R</sub> =20V		25	nA
$BV_R$	I <sub>R</sub> =5.0μA	75		V
$BV_R$	I <sub>R</sub> =100μA	100		V
$V_{F}$	I <sub>F</sub> =5.0mA	0.62	0.72	V
$V_{F}$	I <sub>F</sub> =100mA		1.0	V
$C_T$	V <sub>R</sub> =0, f=1.0MHz		4.0	pF
t <sub>rr</sub>	$I_R = I_F = 10$ mA, $I_{rr} = 1.0$ mA, $R_L = 100$ Ω		4.0	ns

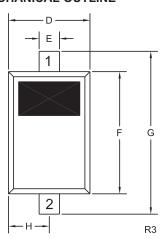
### CMOD4448

### **SURFACE MOUNT** HIGH SPEED SILICON SWITCHING DIODE



# **SOD-523 CASE - MECHANICAL OUTLINE**





### LEAD CODE:

- 1) Cathode 2) Anode

**MARKING CODE: 48** 

DIMENSIONS						
	INCHES		MILLIMETERS			
SYMBOL	MIN	MAX	MIN	MAX		
Α	0.020	0.031	0.50	0.80		
В	0.008	0.016	0.20	0.40		
С	0.002	0.008	0.05	0.20		
D	0.028	0.035	0.70	0.90		
E	0.008	0.014	0.20	0.35		
F	0.039	0.055	1.00	1.40		
G	0.055	0.071	1.40	1.80		
Н	0.016		0.40			
SOD-523 (REV: R3)						

R6 (11-April 2011)

#### **OUTSTANDING SUPPORT AND SUPERIOR SERVICES**



#### PRODUCT SUPPORT

Central's operations team provides the highest level of support to insure product is delivered on-time.

- Supply management (Customer portals)
- · Inventory bonding
- · Consolidated shipping options

- · Custom bar coding for shipments
- · Custom product packing

#### **DESIGNER SUPPORT/SERVICES**

Central's applications engineering team is ready to discuss your design challenges. Just ask.

- Free guick ship samples (2<sup>nd</sup> day air)
- Online technical data and parametric search
- SPICE models
- · Custom electrical curves
- · Environmental regulation compliance
- · Customer specific screening
- · Up-screening capabilities

- Special wafer diffusions
- PbSn plating options
- Package details
- Application notes
- · Application and design sample kits
- · Custom product and package development

#### REQUESTING PRODUCT PLATING

- 1. If requesting Tin/Lead plated devices, add the suffix "TIN/LEAD" to the part number when ordering (example: 2N2222A TIN/LEAD).
- 2. If requesting Lead (Pb) Free plated devices, add the suffix "PBFREE" to the part number when ordering (example: 2N2222A PBFREE).

#### **CONTACT US**

#### Corporate Headquarters & Customer Support Team

Central Semiconductor Corp. 145 Adams Avenue Hauppauge, NY 11788 USA

Main Tel: (631) 435-1110 Main Fax: (631) 435-1824

Support Team Fax: (631) 435-3388

www.centralsemi.com

Worldwide Field Representatives: www.centralsemi.com/wwreps

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